

PHOTOSENSITIVE DIELECTRIC RESIN COMPOSITIONS, FILMS
FORMED THEREFROM AND SEMICONDUCTOR AND DISPLAY DEVICES
ENCOMPASSING SUCH FILMS

Abstract

Some embodiments in accordance with the present invention relate to norbornene-type polymers and to photosensitive dielectric resin compositions formed therefrom. Other embodiments relate to films formed from such compositions and to devices, such as electrical, electronic and optoelectronic devices, that encompass such films.